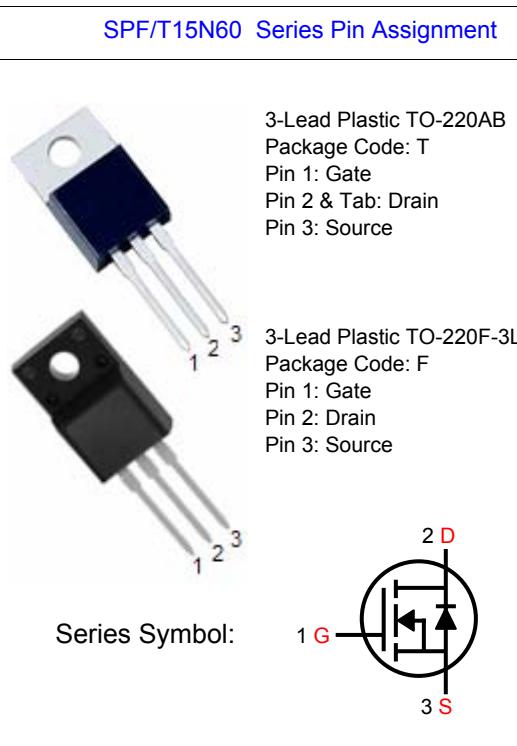
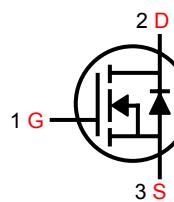


Industrial model	Package identification	Packing method	Quantity per tube	Quantity per box	Quantity per carton
SPT15N60 SPF15N60	T: TO-220AB F: TO-220F-3L	TUBE	50/tube	1Kpcs/box	5Kpcs

<p>■ Features</p> <p>Originative New Design Superior Avalanche Rugged Technology Robust Gate Oxide Technology Very Low Intrinsic Capacitances Excellent Switching Characteristics Unrivalled Gate Charge: 48.5nC(Typ.) Extended Safe Operating Area Lower $R_{DS(ON)}$: 0.49Ω(Typ.) @ $V_{GS}=10V$ 100% Avalanche Tested Package: TO-220AB & TO-220F-3L</p>	$I_D=15A$ $BV_{DSS}=600V$ $R_{DS(on)}=0.52\Omega$	<p>SPF/T15N60 Series Pin Assignment</p>  <p>3-Lead Plastic TO-220AB Package Code: T Pin 1: Gate Pin 2 & Tab: Drain Pin 3: Source</p> <p>3-Lead Plastic TO-220F-3L Package Code: F Pin 1: Gate Pin 2: Drain Pin 3: Source</p> <p>Series Symbol:</p> 
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■ Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	V_{DSS}	600	V
Gate to Source Voltage	V_{GSS}	± 30	V
Avalanche Current (Note 2)	I_{AR}	15	A
Continuous Drain Current	I_D	15	A
	I_{DM}	60	A
Avalanche Energy	E_{AS}	637	mJ
	E_{AR}	25.0	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.5	V/ns
Power Dissipation	P_D	38.5	W
		312	
Junction Temperature	T_J	+150	°C
Storage Temperature	T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. $L=5.23mH$, $I_{AS}=15A$, $V_{DD}= 50V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$

4. $I_{SD} \leq 15A$, $di/dt \leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25^\circ C$

■ Thermal Data

Parameter	Symbol	Ratings	Unit
Junction to Ambient	θ_{JA}	62.5	°C/W
TO-220AB		40	
Junction to Case	θ_{JC}	3.3	°C/W
TO-220AB		0.4	

■ Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

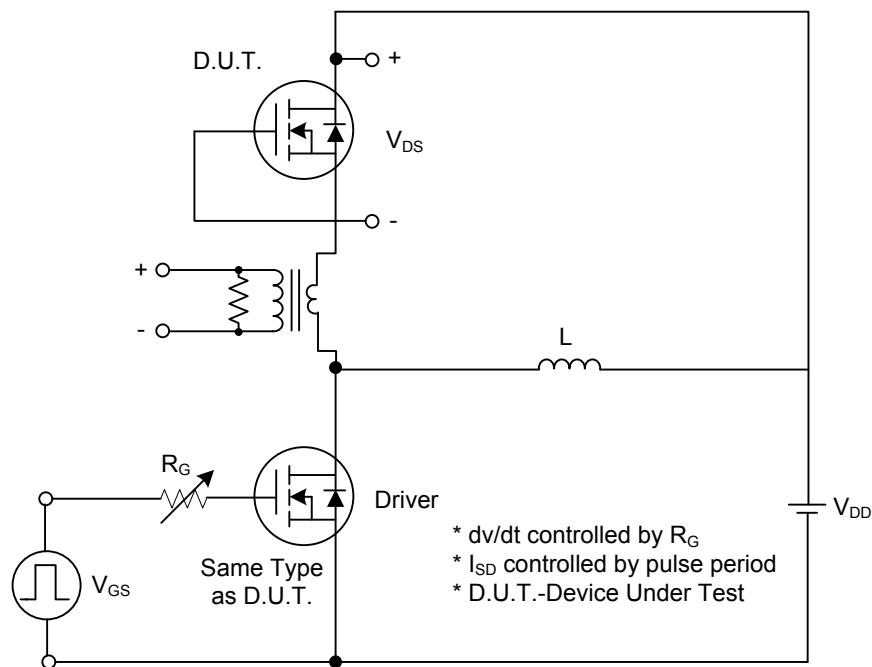
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}, T_J=25^\circ\text{C}$	600			V
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$, Referenced to 25°C		0.65		$^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$ $V_{\text{DS}}=520\text{V}, T_C=125^\circ\text{C}$		1		μA
Gate- Source Leakage Current	Forward Reverse	$V_{\text{GS}}=+30\text{V}, V_{\text{DS}}=0\text{V}$ $V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$		+100		nA
				-100		nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=7.5\text{A}$		0.49	0.52	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		2380	3095	pF
Output Capacitance	C_{OSS}			295	385	pF
Reverse Transfer Capacitance	C_{RSS}			23.6	35.5	pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{\text{DS}}=520\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=15\text{A}$ (Note 1, 2)		48.5	63.0	nC
Gate-Source Charge	Q_{GS}			14.0		nC
Gate-Drain Charge	Q_{GD}			21.2		nC
Turn-ON Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DD}}=325\text{V}, I_{\text{D}}=15\text{A}, R_{\text{G}}=21.7\Omega$ (Note 1, 2)		65	140	ns
Turn-ON Rise Time	t_R			125	260	ns
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			105	220	ns
Turn-OFF Fall Time	t_F			65	140	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				15	A
Maximum Body-Diode Pulsed Current	I_{SM}				60	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=15\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$V_{\text{GS}}=0\text{V}, I_S=15\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$ (Note 1)		496		ns
Body Diode Reverse Recovery Charge	Q_{RR}			5.69		μC

Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$

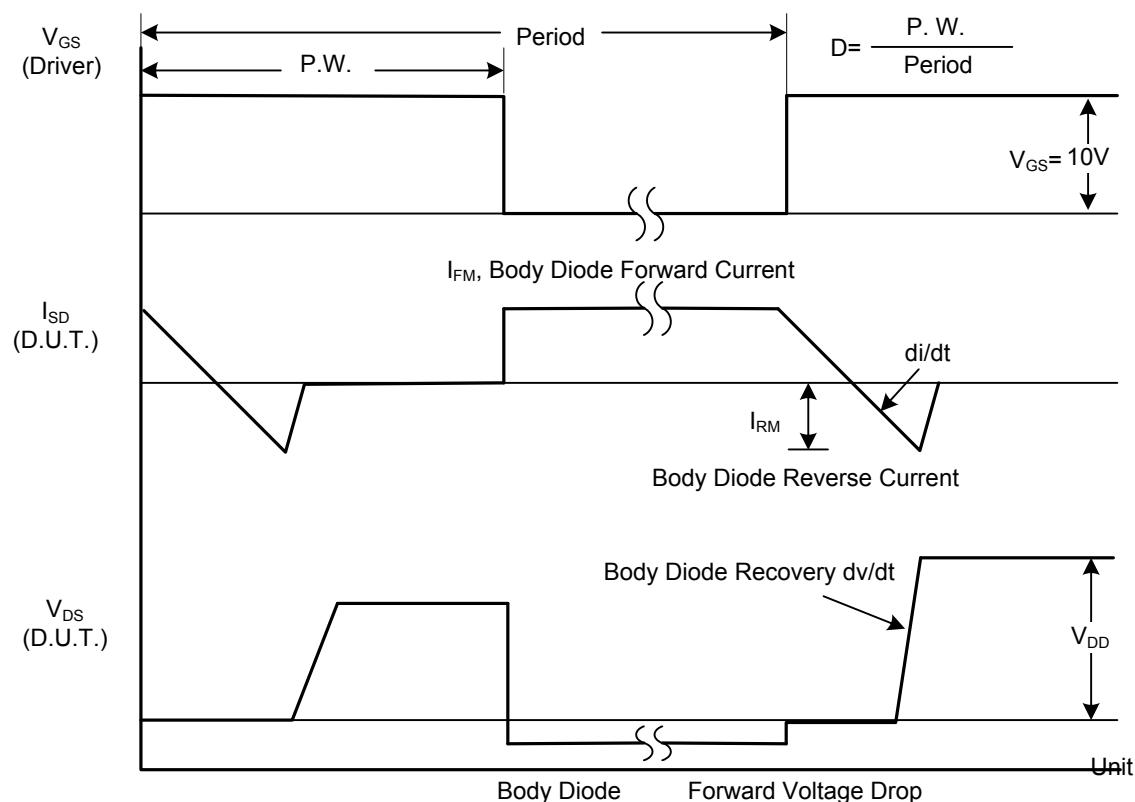
2. Essentially independent of operating temperature

3. Drain current limited by maximum junction temperature

■ Test circuits and waveforms

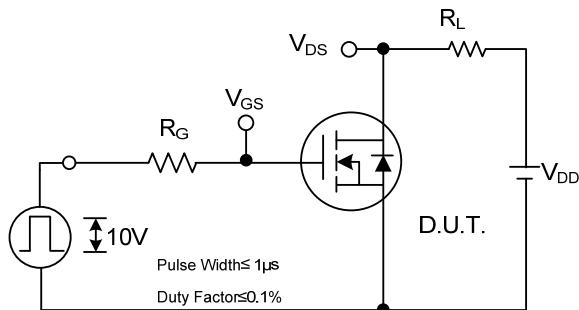


Peak Diode Recovery dv/dt Test Circuit

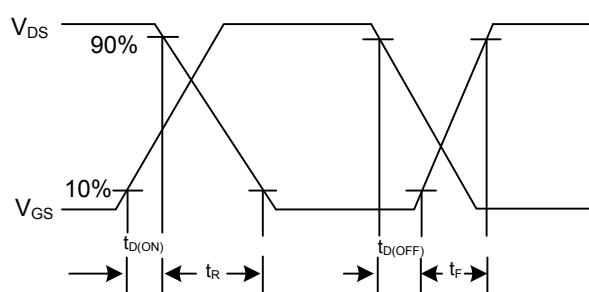


Peak Diode Recovery dv/dt Waveforms

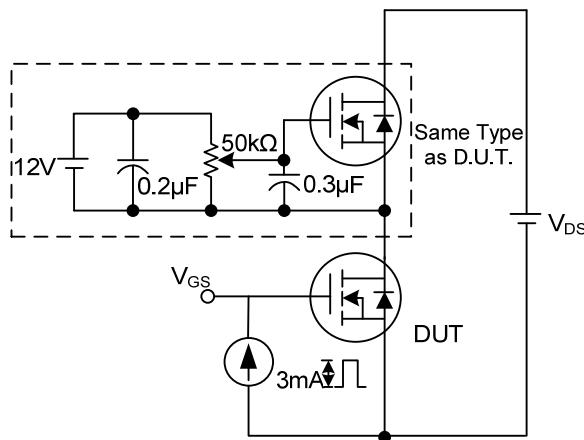
■ Test circuits and waveforms(Cont.)



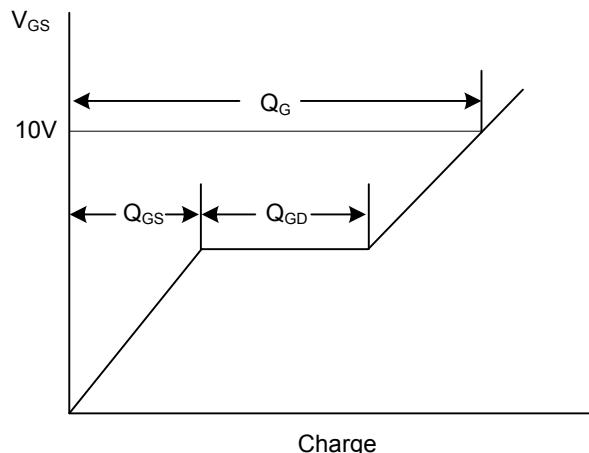
Switching Test Circuit



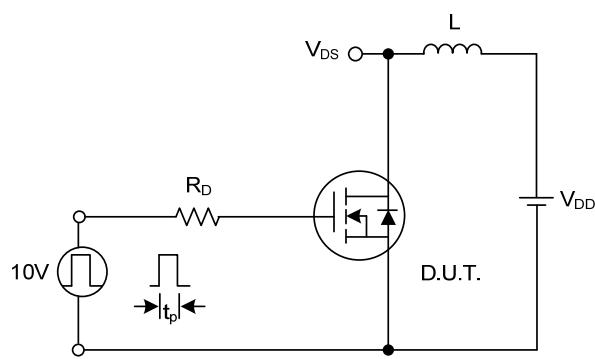
Switching Waveforms



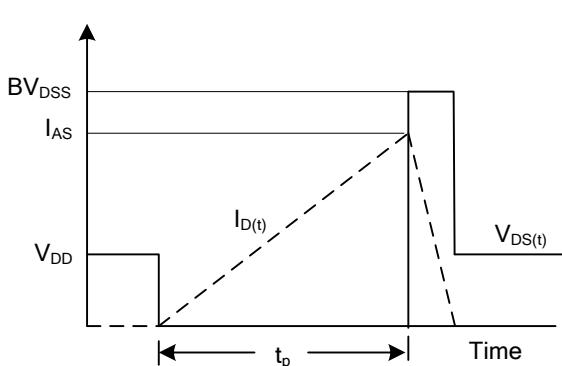
Gate Charge Test Circuit



Gate Charge Waveform

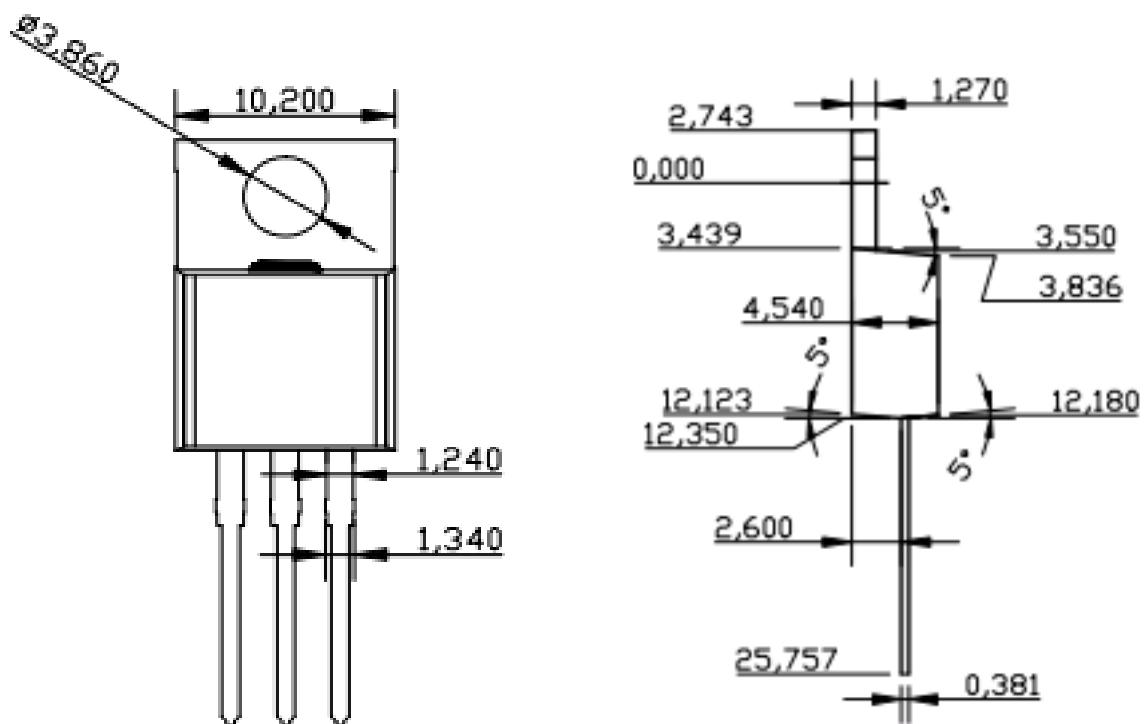


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

■ TO-220-3L Package outline dimensions



■ TO-220F-3L Package outline dimensions

